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## N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 160 A, 2.0 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 2.0 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 28 A
- Max  $r_{DS(on)} = 2.4 \text{ m}\Omega$  at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 25 \text{ A}$
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

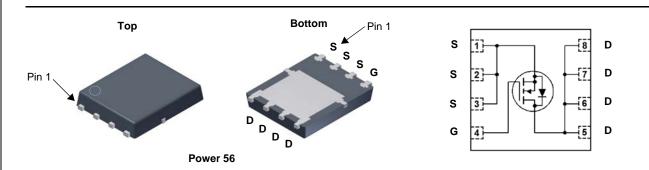


## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

### Applications

- VRM Vcore Switching For Desktop And Server
- OringFET / Load Switching
- DC-DC Conversion



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 6)	160		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 6)	101		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	28	Α	
	-Pulsed		(Note 5)	634		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	294	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		78	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	1.6	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient (Note 1a	) 50	C/VV

#### Package Marking and Ordering Information

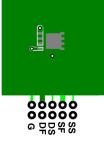
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8820	FDMS8820	Power 56	13 "	12 mm	3000 units

FDMS8820
N-Channel
PowerTrench <sup>®</sup>
<sup>®</sup> MOSFET

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
			WIIII	ιγρ	Max	Units	
	cteristics			1	1	1	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu A,$ referenced to 25 °C		19		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.2	1.5	2.5	V	
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A		1.4	2.0	mΩ	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 25 A		1.8	2.4		
- ( - )		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A, T <sub>J</sub> = 125 °C		2.0	2.8	1	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 28 \text{ A}$		76		S	
C <sub>iss</sub>	Characteristics Input Capacitance	$V_{22} = 15 V V_{22} = 0 V$		3995	5315	pF	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1295	1725	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			177	270	pF	
R <sub>g</sub>	Gate Resistance		0.1	1.1	2.5	Ω	
Switching	Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			14	25	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 28 A,		7.7	16	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		41	66	ns	
t <sub>f</sub>	Fall Time	-		6.4	13	ns	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		63	88	nC	
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V},$		30	42	nC	
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 28 A		9.8		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			8.2		nC	
Drain-Soເ	Irce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.0 A$ (Note 2)		0.7	1.1		
		$V_{GS} = 0 V, I_S = 28 A$ (Note 2)		0.8	1.2	V	
t <sub>rr</sub>	Reverse Recovery Time			43	69	ns	
	-	I <sub>F</sub> = 28 A, di/dt = 100 A/μs				1	

Notes: 1. R<sub>0,A</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



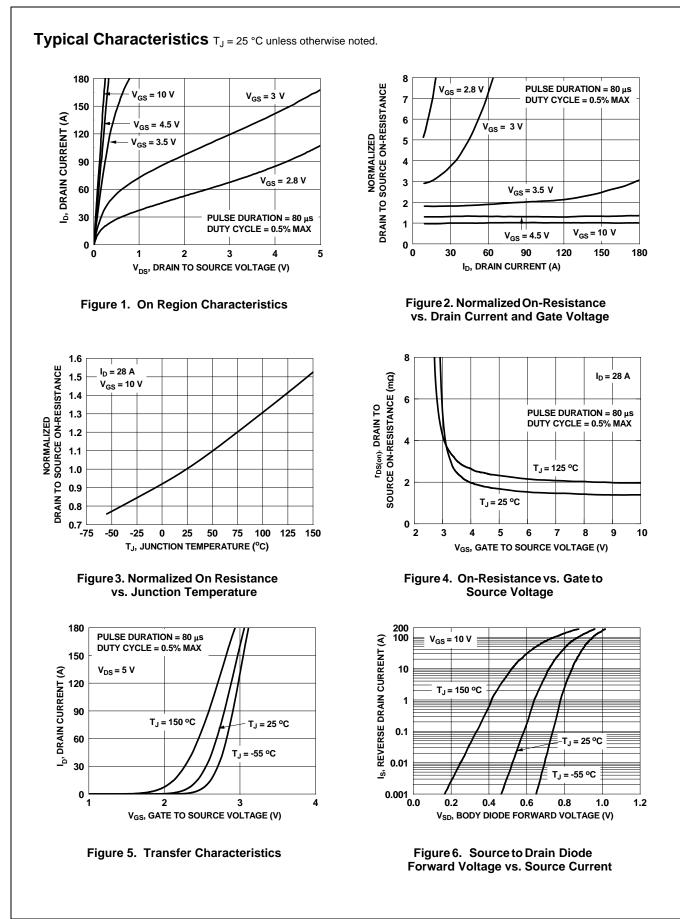
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

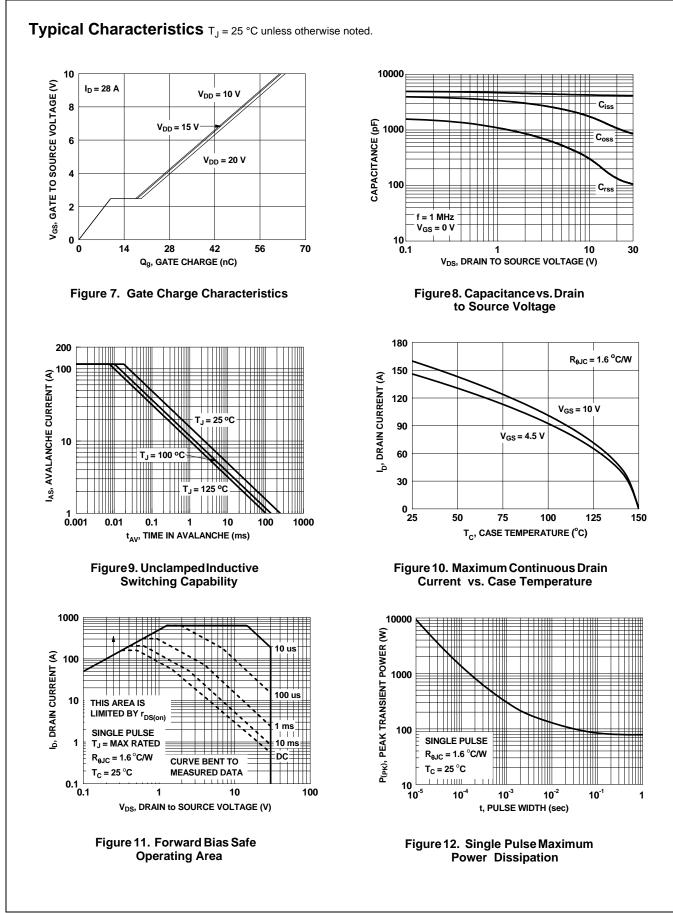
3.  $E_{AS}$  of 294 mJ is based on starting  $T_J$  = 25 °C; N-ch: L = 3 mH,  $I_{AS}$  = 14 A,  $V_{DD}$  = 30 V,  $V_{GS}$  = 10 V. 100% test at L = 0.1 mH,  $I_{AS}$  = 45 A. 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

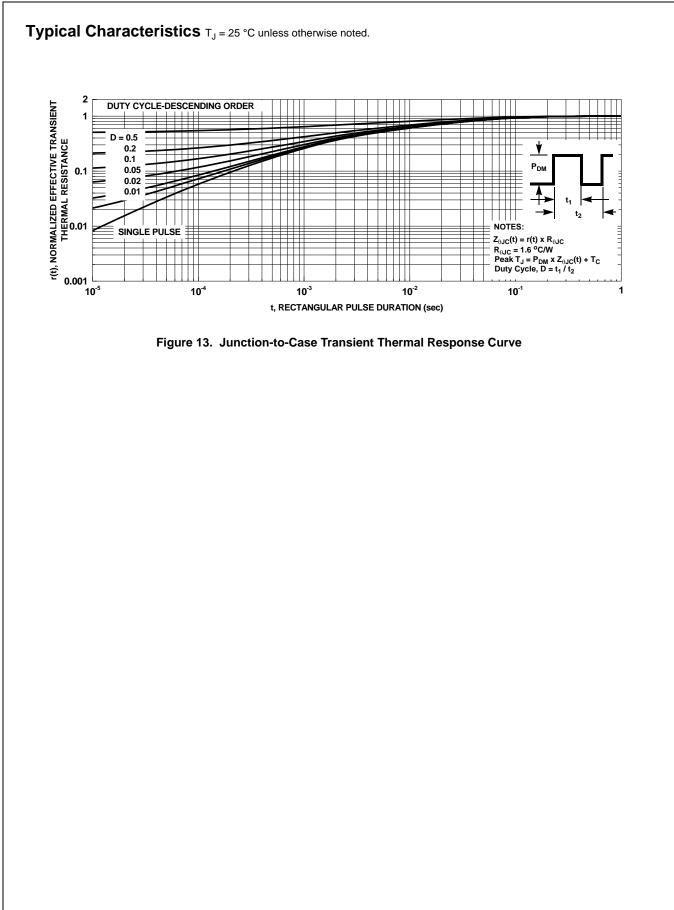
5. Pulsed Id please refer to SOA curve for more details.

6. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.











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